

ROHS COMPLIANT

IPI80N04S4-04-VB Datasheet N-Channel 45-V (D-S) MOSFET

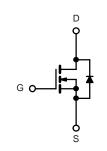
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	R _{DS(on)} (Ω) I _D (A) ^{a, c}			
45	0.0057 at V _{GS} = 10 V	75	240 nC		
	0.0060 at V _{GS} = 4.5 V	70	240110		

FEATURES

- Trench Power MOSFET
- 100 % Rg and UIS Tested

APPLICATIONS

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, unle	ss otherwise not	ed	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	45	V	
Gate-Source Voltage	V _{GS}	± 25	V	
	T _C = 25 °C		75 ^{a, c}	
Continuous Drain Current (T $= 175$ °C)	T _C = 70 °C		70 ^c	
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	29 ^b	A
	T _A = 70 °C		23 ^b	
Pulsed Drain Current		I _{DM}	250	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	80	
Single Pulse Avalanche Energy		E _{AS}	320	V
Continueur Course Drain Diada Current	T _C = 25 °C	la la	110 ^{a, c}	A
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.6 ^b	A
	T _C = 25 °C		312 ^a	
Mauinum Davian Diasis atian	T _C = 70 °C	Б	200	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.13 ^b	W
	T _A = 70 °C		2.0 ^b	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.33	0.4		

Notes:

a. Based on $T_C = 25$ °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.



SPECIFICATIONS $T_J = 25 \text{ °C}, \text{ t}$	1			-	N.4.		
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			40	1	[L	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		41		- mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40 V, V_{GS} = 0 V			1	μΑ	
	000	V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	120			A	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0057		Ω	
	"DS(on)	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0060			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		180		S	
Dynamic ^b							
Input Capacitance	C _{iss}			18800		pF	
Output Capacitance	C _{oss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz		1550			
Reverse Transfer Capacitance	C _{rss}			850			
Total Gate Charge	Qg			240	360	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = 20 V, V_{GS} = 10 V, I_D = 20 A		40			
Gate-Drain Charge	Q _{gd}			22			
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t _{d(on)}			20	30	-	
Rise Time	t _r	V_{DD} = 20 V, R_L = 1.0 Ω		11	17		
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ 20 A, V_{GEN} = 10 V, R_{g} = 1 Ω		77	115		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			102	155	ns	
Rise Time	t _r	V_{DD} = 20 V, R_L = 1.0 Ω		62	95	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 20 A, V_{GEN} = 4.5 V, R_g = 1 Ω		180	270		
Fall Time	t _f			60	90		
Drain-Source Body Diode Characteristic	s					I	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			110	۸	
Pulse Diode Forward Current ^a	I _{SM}				200	A	
Body Diode Voltage	V _{SD}	I _S = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			50	75	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			70	105	nC	
Reverse Recovery Fall Time	ta	I _F = 20 A, di/dt = 100 A/μs, T _J = 25 °C		30			
Reverse Recovery Rise Time	t _b	-		20		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

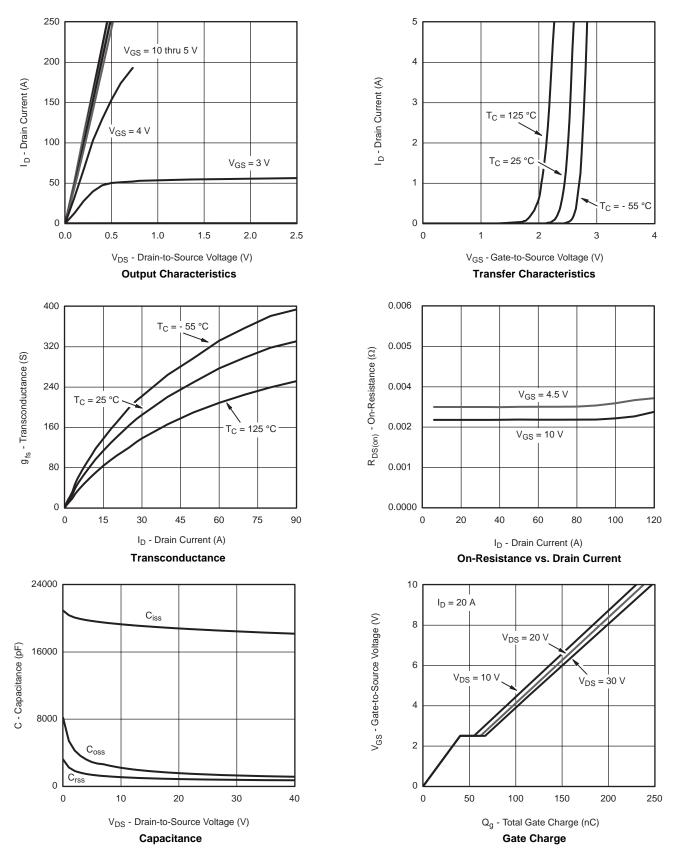
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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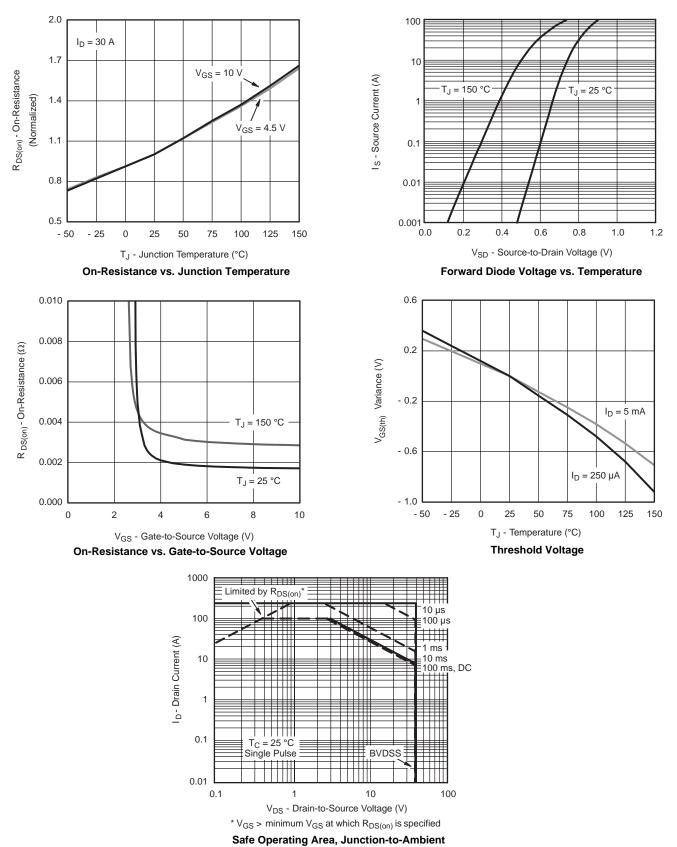
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



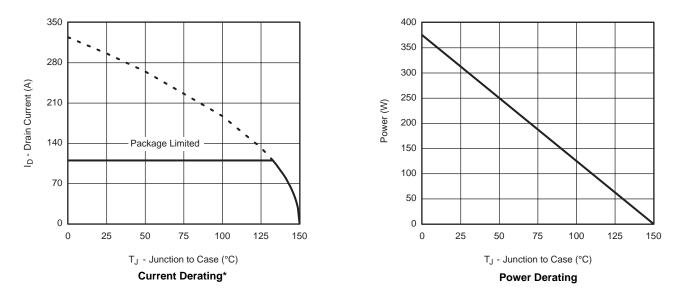
服务热线:400-655-8788



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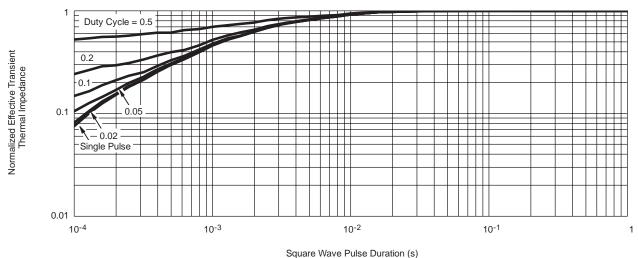






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* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



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